

C1210C129DATACTU

Aliases (C1210C129DATAC7800) SMD Comm X8G HT150C, Ceramic, 1.2 pF, +/-0.5 pF, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



Click here for the 3D model.

General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	30 mg	
Shelf Life	78 Weeks	
MSL	1	

1.2 pF

		Specifications
	1210	Capacitance
	3.2mm +/-0.2mm	Measurement Condition
	2.5mm +/-0.2mm	Tolerance
	0.78mm +/-0.10mm	Voltage DC
	1.5mm MIN	Dielectric Withstanding Volta
	0.5mm +/-0.25mm	Temperature Range
		Temp. Coefficient
ecifications		Capacitance Change with Reference to +25°C and 0 VD
	T&R, 180mm, Plastic Tape	

Packaging Specifications	
Packaging	T&R, 180mm, Plas
Packaging Quantity	4000

Dimensions Chip Size

L W T S B

	Measurement Condition	1 MHz 1.0Vrms
	Tolerance	+/-0.5 pF
	Voltage DC	250 VDC
	Dielectric Withstanding Voltage	625 VDC
	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
	Insulation Resistance	100 GOhms

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